

**DEXRON® Thermal Conductivity Test– ASTM D7896**  
**Report Form**  
**Form 1**  
**Version**

<b>Formulation Code</b>							
Formulation Code							
SID	SponsorCode	Modification	Blend	Method	Count	Lab	Test Cell

<b>Blended Sample Testing Information<sup>A</sup></b>			
Candidate Percentage		Other Percentage	
Other Fluid ID			

<sup>A</sup>If not a Blended Sample then report 100% Candidate Percentage, 0% Other Percentage, and “None” for Blend Fluid ID.

<b>Test Identification</b>			
Sponsor			
Sponsor In-House Number			
Lab In-House Number			
Alternate Code			
Test Number <sup>B</sup>			
Test Cell		Run Number	
Start Date		Start Time	
EOT Date		EOT Time	

<sup>B</sup>Test Number = Test Cell (conductivity cell) – Run Number

<b>Test Validity Statement</b>	
This test has been conducted in a valid manner – YES or NO	
Test Laboratory	
Signature	
Typed Name	
Title	

**DEXRON® Thermal Conductivity Test – ASTM D7896**  
**Pass/Fail Results**  
**Form 2**

Formulation Code	
Test Number	

<b>Pass/Fail Results</b>		
Temperature (°C)	Average Thermal Conductivity (W/m-K)	
	New	Used
40		
70		
100		
130		
170		

<b>Additional Test Identification Information</b>		
Item	New	Used
Used Fluid Conditioning <sup>A</sup>		
Start Date		
Start Time		
EOT Date		
EOT Time		

<sup>A</sup> Used Fluid Condition Values	Used Fluid Condition Description
DKA	Deutscher Koordinierungsausschuss (DKA)

<b>Comments</b>